



description

Unitrode Products

from Texas Instruments

†For the UCC5647, Pin 47 is DISCNCT1 and Pin 48 is DISCNCT2.

The UCC5646 is a twenty-seven line active terminator for low-voltage-differential (LVD) SCSI networks. This LVD SCSI-only design allows the user to reach peak bus performance, while reducing system cost. The device is designed as an active Y-terminator to improve the frequency response of the LVD SCSI Bus. Designed with a 2-pF (typical) channel capacitance, the UCC5646 allows for minimal bus loading for a maximum number of peripherals. With the UCC5646, the designer is able to comply with the Ultra2, Ultra3, Ultra160 and Ultra320 specifications. The UCC5646 also provides a much-needed system migration path for the ever improving SCSI system standards.

This device is available in the 64-pin low-profile QFP package for ease of layout use.

Single-ended (SE) and high-voltage differential (HVD) SCSI drivers are not supported.

AVAILABLE OPTIONS					
	DISCONNECT	PACKAGED DEVICES [†]			
TA	STATUS	LOW PROFILE QFP (PM)			
0°C to 70°C	REGULAR	UCC5646PM			
	REVERSE	UCC5647PM			

[†] The PM package is available taped and reeled. Add TR suffix to device type (e.g. UCC5646PMTR) to order quantities of 1000 devices per reel.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



Copyright © 2001, Texas Instruments Incorporated

UCC5646, UCC5647 27-LINE 3-V - 5-V LVD TERMINATOR FOR WIDE ULTRA2, ULTRA3, ULTRA160 AND ULTRA320 SLUS386B – FEBRUARY 2000 – REVISED APRIL 2001

block diagram



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)^{†‡}

Input voltage V _{IN} (STRMPWR, PTRMPWR)	6 V
Signal line input voltage	0 V to 5 V
Regulator output current	0.75 A
Storage temperature range, T _{stg}	–55°C to 150°C
Operating virtual junction temperature range, TJ	–55°C to 150°C
Lead temperature (soldering, 10 seconds)	300°C

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[‡] Unless otherwise indicated, voltages are reference to ground and currents are positive into and negative out of the specified terminals. Consult Packaging Section of the Databook for thermal limitations and considerations of packages. All voltages are referenced to GND.



UCC5646, UCC5647 27-LINE 3-V - 5-V LVD TERMINATOR FOR WIDE ULTRA2, ULTRA3, ULTRA160 AND ULTRA320 SLUS386B - FEBRUARY 2000 - REVISED APRIL 2001

electrical characteristics over recommended operating free-air temperature range, xTRMPWR = 2.7 V to 5.25 V, $T_A = 0^{\circ}C$ to 70°C, DISCNCT1 = DISCNCT2 = 0 V for UCC5646, DISCNCT1 = DISCNCT2 = open for UCC5647, $T_A = T_J$, (unless otherwise noted)

PARAMETER	TEST CONDITIO	MIN	TYP	MAX	UNIT			
xTRMPWR Supply Current Section								
	LVD mode				65	mA		
XIRMPWR supply current	Disabled terminator				500	μA		
1.25 V Regulator Section	1.25 V Regulator Section							
1.25 V regulator	$0.5 \text{ V} \le \text{V}_{CM} \le 2.0 \text{ V},$	See Note 1	1.15	1.25	1.35	V		
Regulator source current	V _{REG} = 0 V			-300	-240	mA		
Regulator sink current	V _{REG} = 3.0 V		240	300		mA		
1.3 V (DIFSENS) Regulator Section								
1.3 V regulator	$-5mA \le I_{DIFSENS} \le 50 \ \mu A$		1.2	1.3	1.4	V		
Short-circuit source current	VDIFSENS = 0 V		-5	-8	-15	mA		
Short-circuit sinkcurrent	VDIFSENS = 2.75 V		50		200	μΑ		
Differential Termination Section (Applies to eac	h line pair 1–27)							
Differential bias voltage			100		125	mV		
Differential impedance			100	105	110	Ω		
Common-mode bias voltage	L+ and L- shorted together		1.15	1.25	1.35	V		
Common-mode impedance	L+ and L- shorted together, S	See Note 2	110	140	165	Ω		
Disconnected Termination Section								
Output leakage current				10	400	nA		
Output capacitance	SE measurement to GND, SE	See Note 3			3	pF		
Disconnect Control (DISCNCT1) or (DISNCNT2)	and DIFFB Input Section							
DISCNCT threshold voltage			0.8	1.5	2.0	V		
DISCNCT input current	VDISCNCT = 0 V and 2.0 V		-30		-10	μA		
DIFFB SE to LVD threshold voltage			0.5		0.7	V		
DIFFB LVD to HPD threshold voltage			1.9		2.4	V		
DIFFB Input current	$0 \text{ V} \leq \text{V}_{\text{DIFFB}} \leq 2.75 \text{ V},$		-10		10	μΑ		
Low-Voltage Differential (LVD) Status Bit Section								
Source current	$V_{LOAD} = 2.4 V$			-6	-4	mA		
Sink current	$V_{LOAD} = 0.4 V$		2	5		mA		
Thermal Shutdown Section								
Thermal shutdown threshold	For increasing temperature		140	155	170	°C		
Thermal shutdown hysteresis				10		°C		

NOTE 1: VCM is applied to all L+ and L– lines simultaneously. 2: $Z_{CM} = \frac{1}{\left[I_{V}\right]}$

 $\frac{2.0 \text{ V} - 0.5 \text{ V}}{1000 \text{ C}}$, $\text{V}_{\text{CM}(\text{max})} = 2.0 \text{ V}$, $\text{V}_{\text{CM}(\text{min})} = 0.5 \text{ V}$

NOTE 3: Ensured by design, not production tested.



UCC5646, UCC5647 27-LINE 3-V – 5-V LVD TERMINATOR FOR WIDE ULTRA2, ULTRA3, ULTRA160 AND ULTRA320 SLUS386B – FEBRUARY 2000 – REVISED APRIL 2001

pin descriptions

STRMPWR: 2.7 V to 5.25 V power supply for all circuitry except the 1.25-V regulator.

SGND: Ground reference for all circuitry except the 1.25-V regulator.

PTRMPWR: 2.7 V to 5.25 V power supply for the 1.25-V regulator.

PGND: Ground reference for the 1.25-V regulator.

REG: Output of the internal 1.25-V regulator; must be connected to a 4.7-µF bypass capacitor and a high-frequency, low-ESR 0.01-µF capacitor to GND.

DIFSENS: Drives the SCSI bus DIFF SENSE line to 1.3 V to detect what types of devices are tied to the bus.

DIFFB: DIFF SENSE input pin. Connect through a 20-kΩ resistor to DIFSENS and through a 0.1-μF capacitor to GND. Input to comparators that detect what type of drives are connected to the SCSI bus.

DISCNCT1: Disconnect one controls termination lines 10-27 (control and low byte).

DISCNCT2: Disconnect two controls termination lines 1–9 (high byte).

LVD: TTL compatible status bit indicating when low-voltage-differential voltage is present on DIFFB.

L1- thru L27-: Negative lines for the SCSI bus.

L1+ thru L27+: Positive lines for the SCSI bus.



UCC5646, UCC5647 27-LINE 3-V - 5-V LVD TERMINATOR FOR WIDE ULTRA2, ULTRA3, ULTRA160 AND ULTRA320 SLUS386B - FEBRUARY 2000 - REVISED APRIL 2001



Figure 1. Typical Application Diagram



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
UCC5646PM	OBSOLETE	LQFP	PM	64	TBD	Call TI	Call TI
UCC5647PM	OBSOLETE	LQFP	PM	64	TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products		Applications	
Amplifiers	amplifier.ti.com	Audio	www.ti.com/audio
Data Converters	dataconverter.ti.com	Automotive	www.ti.com/automotive
DSP	dsp.ti.com	Broadband	www.ti.com/broadband
Interface	interface.ti.com	Digital Control	www.ti.com/digitalcontrol
Logic	logic.ti.com	Military	www.ti.com/military
Power Mgmt	power.ti.com	Optical Networking	www.ti.com/opticalnetwork
Microcontrollers	microcontroller.ti.com	Security	www.ti.com/security
		Telephony	www.ti.com/telephony
		Video & Imaging	www.ti.com/video
		Wireless	www.ti.com/wireless

Mailing Address:

Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated